



# SPN9926B

## N-Channel Enhancement Mode MOSFET

### DESCRIPTION

The SPN9926B is the Dual N-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application , notebook computer power management and other battery powered circuits where high-side switching .

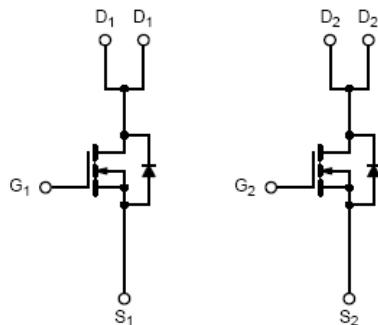
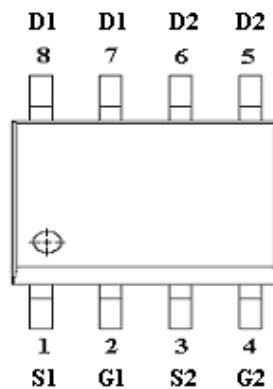
### FEATURES

- ◆ 20V/6.0A,R<sub>DS(ON)</sub>=33mΩ@V<sub>GS</sub>=4.5V
- ◆ 20V/5.0A,R<sub>DS(ON)</sub>=38mΩ@V<sub>GS</sub>=2.5V
- ◆ Super high density cell design for extremely low R<sub>DS(ON)</sub>
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ SOP-8 package design

### APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

### PIN CONFIGURATION(SOP-8)



### PART MARKING



A : Lot Code  
B : Date Code



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### PIN DESCRIPTION

Pin	Symbol	Description
1	S1	Source 1
2	G1	Gate 1
3	S2	Source 2
4	G2	Gate 2
5	D2	Drain 2
6	D2	Drain 2
7	D1	Drain 1
8	D1	Drain 1

### ORDERING INFORMATION

Part Number	Package	Part Marking
SPN9926BS8RGB	SOP-8	SPN9926B

※ SPN9926BS8RGB : 13" Tape Reel ; Pb – Free ; Halogen – Free

### ABSOLUTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V <sub>DSS</sub>	20	V
Gate –Source Voltage	V <sub>GSS</sub>	±12	V
Continuous Drain Current(T <sub>J</sub> =150°C)	I <sub>D</sub>	6.8	A
		4.8	
Pulsed Drain Current	I <sub>DM</sub>	30	A
Continuous Source Current(Diode Conduction)	I <sub>S</sub>	1.6	A
Power Dissipation	P <sub>D</sub>	2.8	W
		1.8	
Operating Junction Temperature	T <sub>J</sub>	-55/150	°C
Storage Temperature Range	T <sub>STG</sub>	-55/150	°C
Thermal Resistance-Junction to Ambient	R <sub>θJA</sub>	105	°C/W



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### ELECTRICAL CHARACTERISTICS

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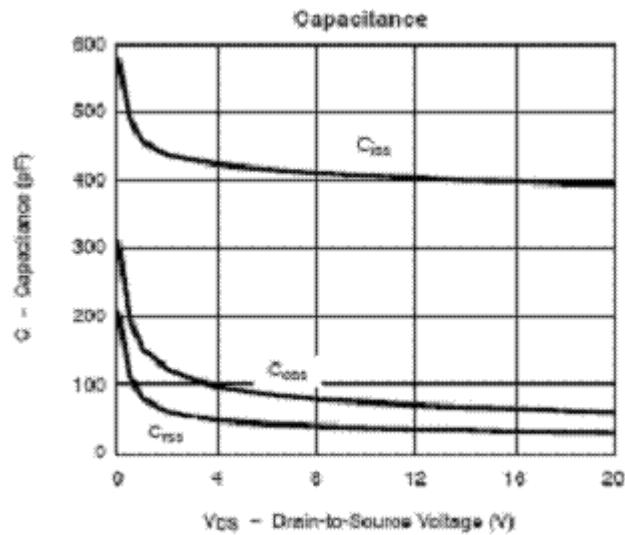
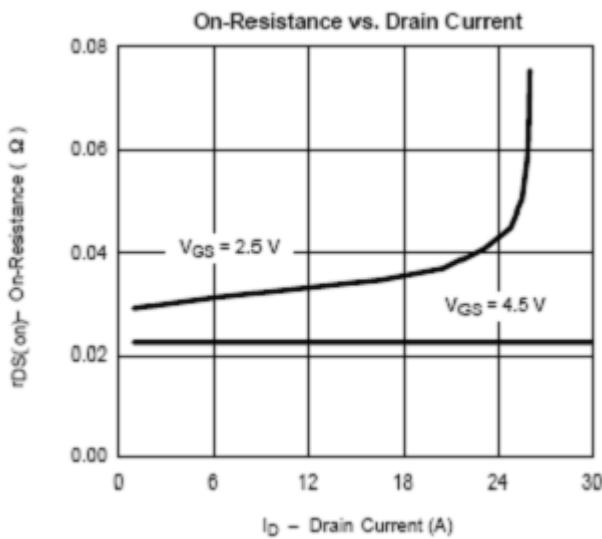
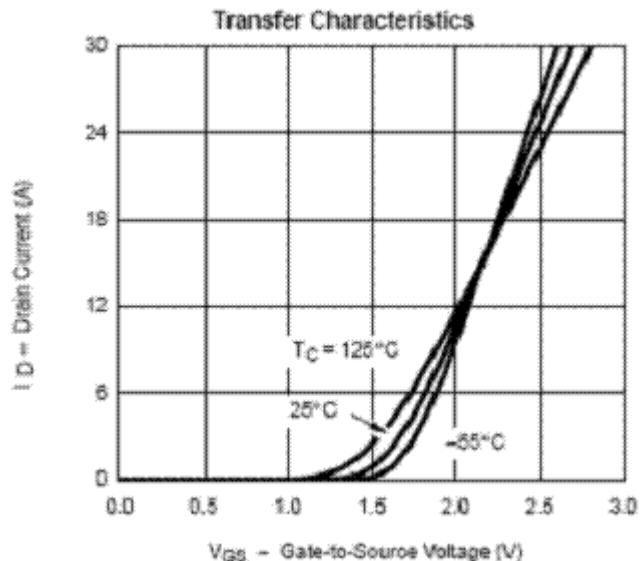
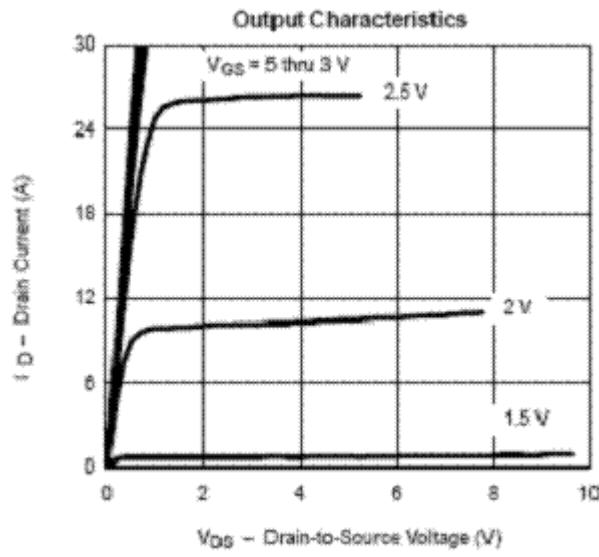
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, ID=250uA	20			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>Ds</sub> =V <sub>GS</sub> , ID=250uA	0.5		1.0	
Gate Leakage Current	I <sub>GSS</sub>	V <sub>Ds</sub> =0V, V <sub>GS</sub> =±12V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>Ds</sub> =20V, V <sub>GS</sub> =0V			1	uA
		V <sub>Ds</sub> =20V, V <sub>GS</sub> =0V T <sub>J</sub> =55°C			5	
On-State Drain Current	I <sub>D(on)</sub>	V <sub>Ds</sub> ≤5V, V <sub>GS</sub> =4.5V	6			A
Drain-Source On-Resistance	R <sub>Ds(on)</sub>	V <sub>GS</sub> =4.5V, ID=6.0A		0.028	0.033	Ω
		V <sub>GS</sub> =2.5V, ID=5.0A		0.032	0.038	
Forward Transconductance	g <sub>fs</sub>	V <sub>Ds</sub> =5V, ID=-3.6A		10		S
Diode Forward Voltage	V <sub>SD</sub>	I <sub>s</sub> =1.7A, V <sub>GS</sub> =0V		0.8	1.2	V
<b>Dynamic</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>Ds</sub> =10V, V <sub>GS</sub> =4.5V, ID=6.0A		2		nC
Gate-Source Charge	Q <sub>gs</sub>			2.5		
Gate-Drain Charge	Q <sub>gd</sub>			2.1		
Input Capacitance	C <sub>iss</sub>	V <sub>Ds</sub> =8V, V <sub>GS</sub> =0V f=1MHz		575		pF
Output Capacitance	C <sub>oss</sub>			84		
Reverse Transfer Capacitance	C <sub>rss</sub>			22		
Turn-On Time	t <sub>d(on)</sub>	V <sub>DD</sub> =10V, R <sub>L</sub> =6Ω ID=1.0A, V <sub>GEN</sub> =4.5V R <sub>G</sub> =6Ω		10	14	nS
	t <sub>r</sub>			16	20	
Turn-Off Time	t <sub>d(off)</sub>			35	40	
	t <sub>f</sub>			3	10	



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### TYPICAL CHARACTERISTICS

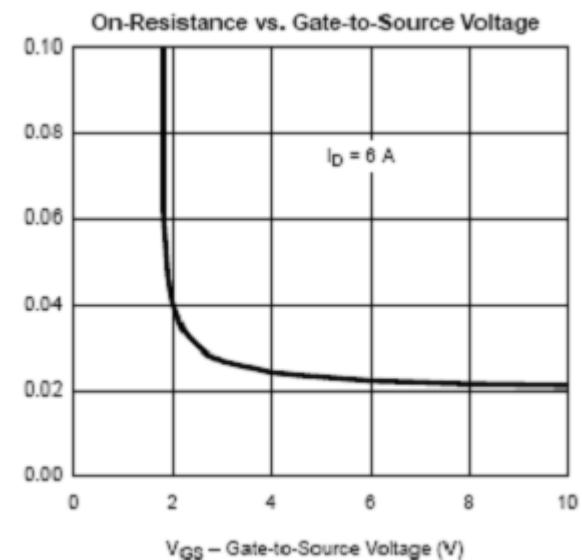
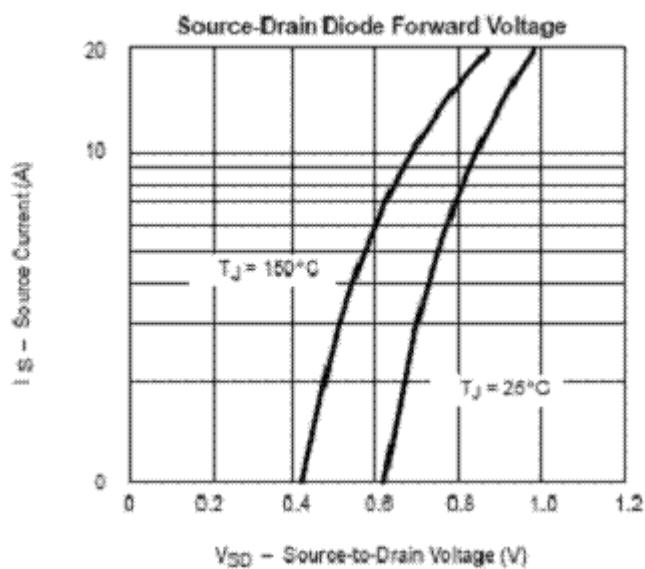
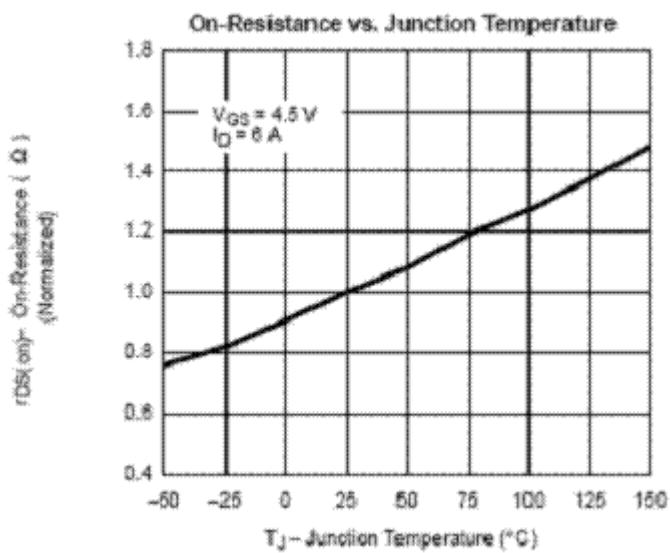
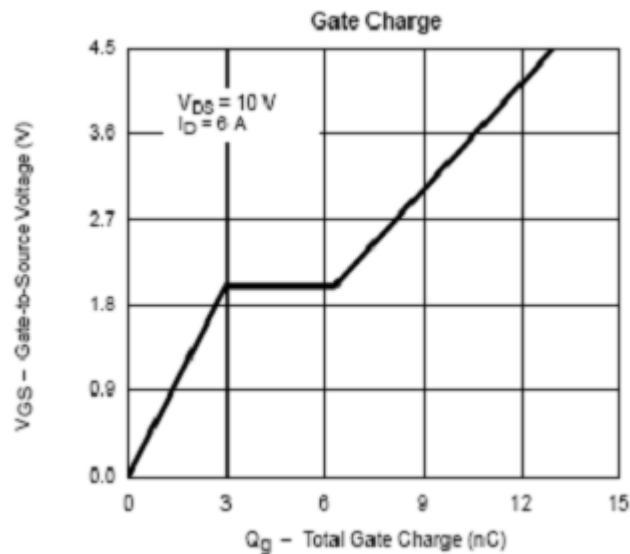




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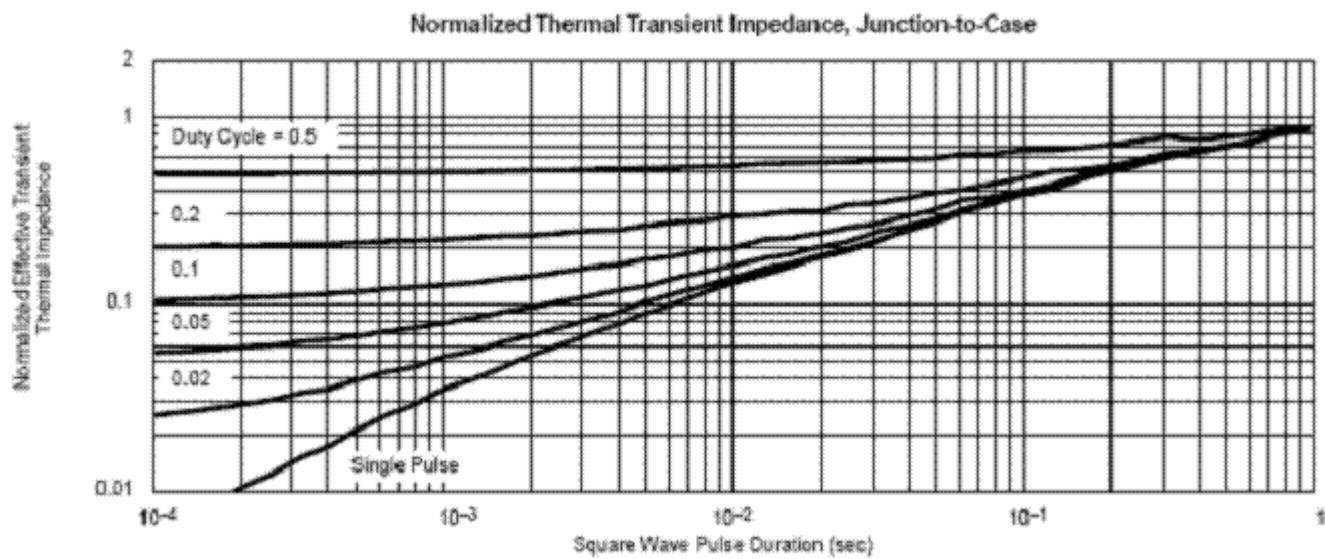
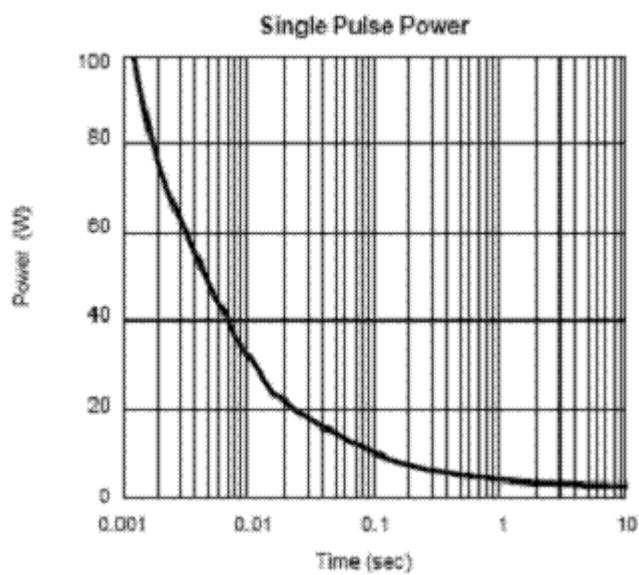
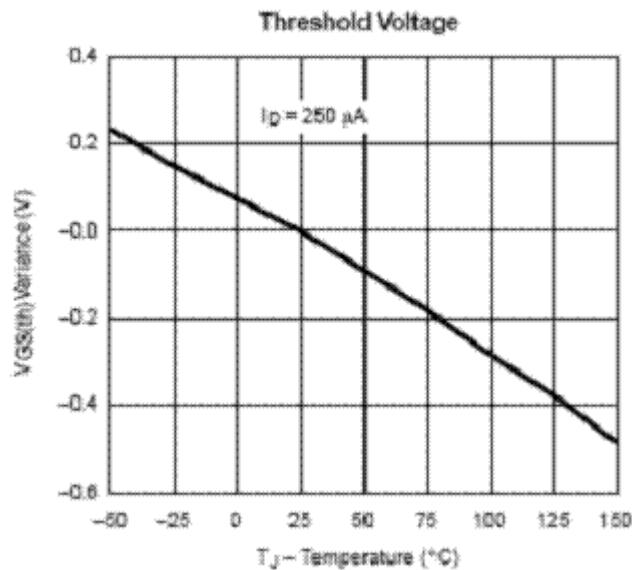




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### TYPICAL CHARACTERISTICS





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